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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hsiao-Ming Huang	06/10/2007
Chun-Lung Wang	06/10/2007
Yi-Lin Yeh	06/10/2007

RECEIVING PARTY DATA

Name:	NOVATEK Microelectronics Corp.	
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City:	Hsin-Chu	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	11762073	

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NAME OF SUBMITTER: WINSTON HSU

Total Attachments: 2

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PATENT REEL: 019417 FRAME: 0801

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S	S) (Inventors):					
Name:	Hsiao-Ming Huang		Nationality:	R.O.C.		
Name:	Chun-Lung Wang		Nationality:	R.O.C.		
Name:	Yi-Lin Yeh		Nationality:	R.O.C.		
Hereby sells, as	signs and transfers to					
ASSIGNEE(S)	:					
Name:	NOVATEK Microelectronics	Corp.				
Address:	2F, No. 13, Innovation Rd. I,	Hsinchu Science P	ark, Hsin-Ch	u 300, Taiwan, R.O.C.		
any and all imp	sors and assignees of the ASS provements which are disclosed	d in the invention e	entitled:			
	ay Device and Related D Memory"	riving Method U	Using Low (Capacity Row		
Which is foun	d in :					
(a)	U.S. patent application executed on even date					
(b)	U.S. patent application executed on					
(c)	U.S. application serial no					
(d) 1	patent no.	issued		<u> </u>		

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this ______ (Date of Signing). (林春州人商必吾基上列日期・)

Signature of INVENTOR (Type name of inventor) Hsiao-Ming Huang Chun-Lung Wang

Assignment, Page

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NPO#NVA-P0048-USA:0 CUST#NVT-2006-093

RECORDED: 06/13/2007

REEL: 019417 FRAME: 0803

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